

# PATENT ASSIGNMENT

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Masamichi YAMAMOTO	11/21/2011
Kyouichirou NAKATSUGI	11/21/2011
Yasuhiro OKUDA	11/21/2011
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SUMITOMO ELECTRIC INDUSTRIES, LTD.
<b>Street Address:</b>	5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi,
<b>City:</b>	Osaka
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	541-0041
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	13377998
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	050395-0508
<b>NAME OF SUBMITTER:</b>	Stephen A. Becker/ksa
<b>Total Attachments: 2</b> source=0503950508assigntransmittal#page1.tif source=0503950508assign#page1.tif	

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**PATENT**  
**REEL: 027377 FRAME: 0993**

**RECORDATION FORM COVER SHEET**

**Docket No.: 050395-0508**

**PATENTS ONLY**

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

**1. Name of Conveying Party(ies)**

**Masamichi YAMAMOTO, Kyouichirou NAKATSUGI,  
Yasuhiro OKUDA**

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

**3. Nature of Conveyance/Execution Date(s)**

Execution Date(s): **November 21, 2011**

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Joint Research Agreement  
☐ Government Interest Assignment  
☐ Executive Order 9424, Confirmatory License

**2. Name and address of receiving party(ies)**

Name: **SUMITOMO ELECTRIC INDUSTRIES, LTD.**

Internal Address:

Address: **5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi,  
Osaka 541-0041 JAPAN**

**4. Application or patent number(s):**

A. Patent Application No(s).

☒ This document is being filed together with a new application.

B. Patent No(s).

**5. Name and address to whom correspondence concerning document should be mailed:**

Name: **MCDERMOTT WILL & EMERY LLP**

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Street Address: **600 13th Street, N.W.**

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D.C.

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Email Address: **mweipdocket@mwe.com**

**6. Total number of applications and patents involved:**

**7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00**

- ☐ Authorized to be charged by credit card  
☒ Authorized to be charged to deposit account  
☐ Enclosed  
☐ None required (government interest not affecting title)

**8. Payment Information:**

- a. Credit Card Last 4 Numbers \_\_\_\_\_  
Expiration Date \_\_\_\_\_  
b. Deposit Account Number **500417**  
Authorized User Name \_\_\_\_\_

**9. Signature.** *Stephen A. Becker* Reg. No. 51,341  
**Stephen A. Becker 26,527**

**December 13, 2011**

Name and Registration No. of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments and documents: **2**

Docket No.: \_\_\_\_\_

## ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) <u>Masamichi YAMAMOTO</u>	(5) _____
(2) <u>Kyouichirou NAKATSUGI</u>	(6) _____
(3) <u>Yasuhiro OKUDA</u>	(7) _____
(4) _____	

who have made a certain new and useful invention, hereby sell, assign and transfer unto

SUMITOMO ELECTRIC INDUSTRIES, LTD. of 5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi, Osaka 541-0041, JAPAN

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

ELECTRODE CONNECTION METHOD, ELECTRODE CONNECTION STRUCTURE, CONDUCTIVE ADHESIVE USED THEREFOR, AND ELECTRONIC DEVICE

(a) for which an application for United States Letters Patent was filed on \_\_\_\_\_, and identified by United States Serial No. \_\_\_\_\_; or

(b) for which an application for United States Letters Patent was executed on \_\_\_\_\_,

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in aid to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dated indicated aside our signatures:

INVENTORS

DATE SIGNED

1) Masamichi Yamamoto  
Name: Masamichi YAMAMOTO

November 21, 2011

2) Kyouichirou Nakatsugi  
Name: Kyouichirou NAKATSUGI

November 21, 2011

3) Yasuhiro Okuda  
Name: Yasuhiro OKUDA

November 21, 2011

PATENT

RECORDED: 12/13/2011

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